THE UNITED STATES PATENT AND TRADEMARK OFFICE

Recip Receipt

Confirmation No. 7449

Kazuhiro OTSU et al.

Docket No.2002-0208A

Serial No. 10/067,370

Group Art Unit 2812

Filed February 7, 2002

SEPARATING MACHINE FOR THINNED SEMICONDUCTOR SUBSTRATE AND

FEE FOR THIS PAPER TO DEPOSIT

ACCOUNT NO. 23-0975

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE

SEPARATION METHOD

REQUEST FOR CORRECTION OF INVENTOR'S NAME

Assistant Commissioner for Patents, Washington, D.C.

Sir:

It is respectfully requested that the fourth inventor's name be changed from "Kazuhiro" OHYA to "Kazuyuki" OHYA.

The error arose in translating inventor Ohya's name from Japanese to English.

A request for corrected Filing Receipt accompanies.

Respectfully submitted,

Kazuhiro OTSU et al.

By:_

Matthew Jacob

Registration No. 25,154

Attorney for Applicants

MJ/pjm Washington, D.C. 20006-1021 Telephone (202) 721-8200 Facsimile (202) 721-8250 May 2, 2002



E UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Kazuhiro OTSU et al.

Confirmation No. 7449

Serial No. 10/067,370

Attn: Office of Initial Patent Examination's

Filing Receipt Correction

Filed February 7, 2002

Attorney Docket No. 2002-0208A

SEPARATING MACHINE FOR THINNED SEMICONDUCTOR SUBSTRATE AND SEPARATION METHOD

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEE FOR THIS PAPER TO DEPOSIT

TC 200 MAIL ROOM

ACCOUNT NO. 23-0975

REQUEST FOR CORRECTED FILING RECEIPT

Assistant Commissioner for Patents, Washington, DC 20231

Sir:

A corrected filing receipt is requested in the above-referenced case. A copy of the original filing receipt is enclosed, with the changes noted thereon.

Expedited issuance of the corrected filing receipt is respectfully requested.

Respectfully submitted,

Kazuhiro OTSU et al.

ъу_

Matthew Jacob

Registration No. 25,154

Attorney for Applicants

MJ/pjm Washington, D.C. 20006-1021 Telephone (202) 721-8200 Facsimile (202) 721-8250 May 2, 2002



COMMISSIQNER FOR PA UNITED STATES PATENT AND PRADEMARK OF

APPLICATION NUMBER

FILING DATE

GRP ART UNIT

FIL FEE REC'D ATTY.DOCKET.NO

DRAWINGS

10/067,370

02/07/2002

2812

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2002-0208A

000513 WENDEROTH, LIND & PONACK, L.L.P. 2033 K STREET N. W. SUITE 800 WASHINGTON, DC 20006-1021



Date Mailed: 04/23/2002

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Kazuhiro Otsu, Tokyo, JAPAN; Hideki Kobayashi, Tokyo, JAPAN; Tatsuya Sasaki, Tokyo, JAPAN; Kazuhiro Ohya, Tokyo, JAPAN;

Domestic Priority data as claimed by applicant

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WENDEROTH, LIND & PONACK

Foreign Applications

JAPAN 30746/01 02/07/2001

If Required, Foreign Filing License Granted 04/05/2002

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Early Publication Request: No

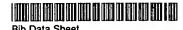
Title

Separating machine for thinned semiconductor substrate and separation method



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UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231 www.uspto.gov



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CONFIRMATION NO. 7449

FILING DATE 02/07/2002 RULE	CLASS 438	GROUP ART 2818			ATTORNEY DOCKET NO. 2002-0208A	
Tokyo, JAPAN; shi, Tokyo, JAPAN; i, Tokyo, JAPAN; , Tokyo, JAPAN; A***********************************	***					
Foreign Priority claimed yes no 35 USC 119 (a-d) conditions yes no Met after Allowance Verified and Acknowledged Examiner's Signature Initials ADDRESS 000513		SHEETS DRAWING 2	DRAWING CLA		INDEPENDENT CLAIMS 2	
or thinned semiconducto	or substrate and separa	ation method				
FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:			☐ All Fees ☐ 1.16 Fees (Filing) ☐ 1.17 Fees (Processing Ext. of time) ☐ 1.18 Fees (Issue) ☐ Other ☐ Credit			
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